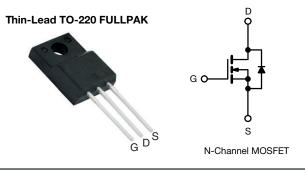
SiHA17N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	850				
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.25				
Q _g max. (nC)	62				
Q _{gs} (nC)	8				
Q _{gd} (nC)	18				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA17N80AE-GE3			

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	800	V	
Gate-source voltage			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C) $^{\circ}$	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	I.	7		
	VGS at TO V	T _C = 100 °C	I _D	4	А	
Pulsed drain current ^a			I _{DM}	32		
Linear derating factor				0.27	W/°C	
Single pulse avalanche energy ^b			E _{AS}	127	mJ	
Maximum power dissipation			PD	34	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	T _J = 125 °C		-l\ / / -l+	100	1//22	
Reverse diode dV/dt d			dV/dt	17	V/ns	
Soldering recommendations (peak temperature) ^c	For 10 s			260	°C	
Mounting torque	M3 screw			0.6	Nm	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.0 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C e. Limited by maximum junction temperature

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-	- 65			80 AN		
Maximum junction-to-case (drain)	R _{thJC}	- 3.7			°C/W			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C,	unless otherw	ise noted)						
PARAMETER	SYMBOL	TES	T CONDITI	ONS	MIN.	TYP.	MAX.	UNIT
Static		-						
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 25	50 µA	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I	_D = 1 mA	-	0.8	-	V/°C
Gate-source threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	50 µA	2.0	-	4.0	V
Octo course lesles es			$V_{GS} = \pm 20$	V	-	-	± 100	nA
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30$	V	-	-	± 1	μA
Zaro gata voltago drain averant	L	V _{DS} =	= 800 V, V _{GS}	s = 0 V	-	-	1	- μA
Zero gate voltage drain current	IDSS	V _{DS} = 640 \	/, V _{GS} = 0 V	, T _J = 125 °C	-	-	10	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D	= 8.5 A	-	0.25	0.29	Ω
Forward transconductance	9 _{fs}	V _{DS}	= 10 V, I _D =	8.5 A	-	7.1	-	S
Dynamic		•				•		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	1260	-	pF	
Output capacitance	C _{oss}			-	56	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$		-	40	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	245	-		
Total gate charge	Qg	V _{GS} = 10 V I _D = 8.5 A, V _{DS} = 640 V		-	41	62	nC	
Gate-source charge	Q _{gs}			-	8	-		
Gate-drain charge	Q _{gd}				-	18	-	1
Turn-on delay time	t _{d(on)}		V _{DD} = 640 V, I _D = 8.5 A,		-	21	42	
Rise time	t _r	V _{DD} =			-	23	46	ns
Turn-off delay time	t _{d(off)}	$V_{\rm GS} = 10$ V, $R_{\rm g} = 9.1$ Ω		-	45	90	115	
Fall time	t _f			-	31	62		
Gate input resistance	R _g	f = 1 MHz, open drain		0.2	0.5	1.1	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	7		
Pulsed diode forward current	I _{SM}			-	-	32	A	
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 8.5 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 8.5 \text{ A},$ $dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 25 \text{ V}$		-	314	628	ns	
Reverse recovery charge	Q _{rr}			-	4	8	μC	
Reverse recovery current	I _{RRM}			-	21	_	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 V to 480 V VDSS

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

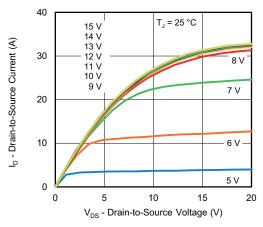


Fig. 1 - Typical Output Characteristics

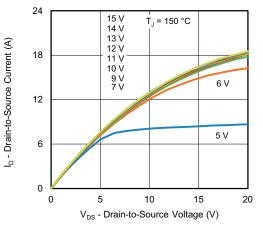


Fig. 2 - Typical Output Characteristics

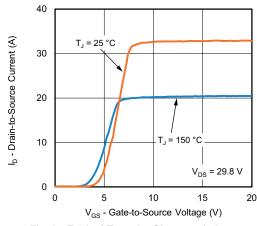


Fig. 3 - Typical Transfer Characteristics

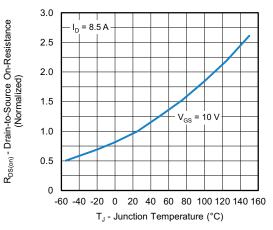


Fig. 4 - Normalized On-Resistance vs. Temperature

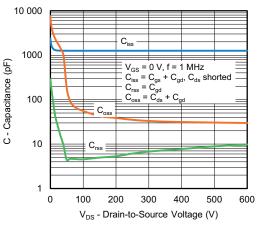
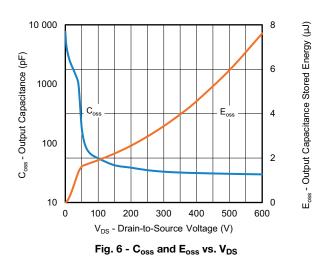


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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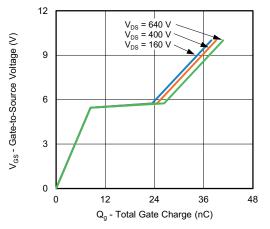


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

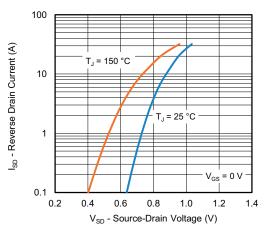


Fig. 8 - Typical Source-Drain Diode Forward Voltage

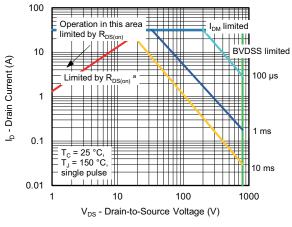


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

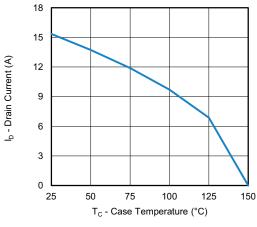


Fig. 10 - Maximum Drain Current vs. Case Temperature

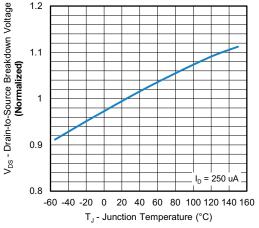


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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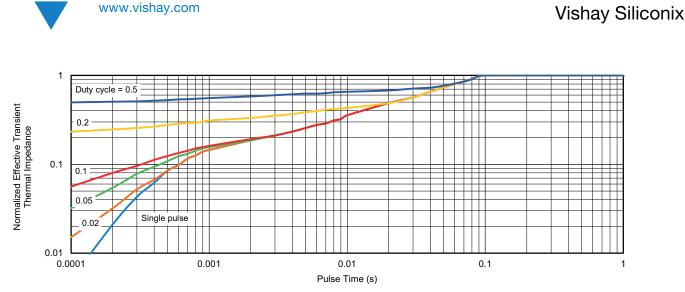


Fig. 12 - Normalized Thermal Transient Impedance, Junction-to-Case

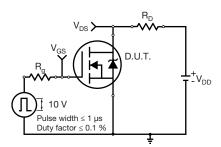


Fig. 13 - Switching Time Test Circuit

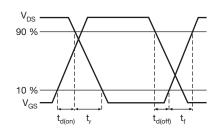


Fig. 14 - Switching Time Waveforms

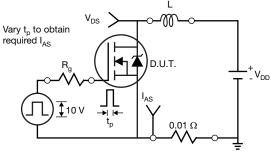
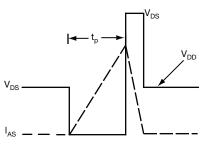


Fig. 15 - Unclamped Inductive Test Circuit



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Fig. 16 - Unclamped Inductive Waveforms

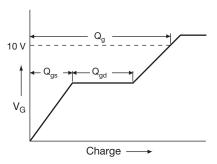


Fig. 17 - Basic Gate Charge Waveform

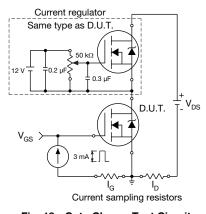


Fig. 18 - Gate Charge Test Circuit

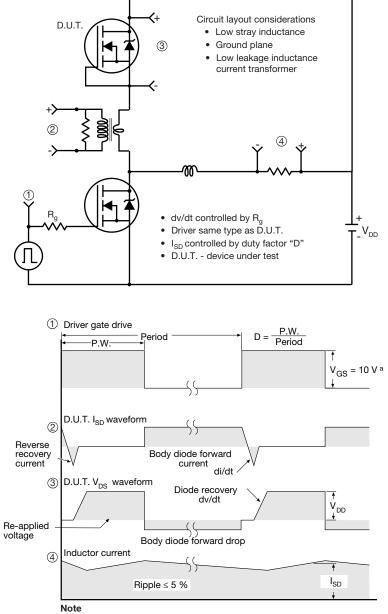
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

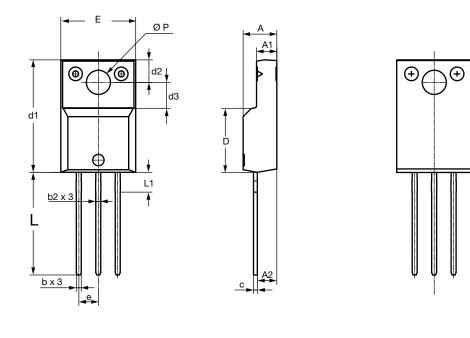
Fig. 19 - For N-Channel

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TO-220 FULLPAK Thin Lead





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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